



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 08/940,686
Filing Date September 30, 1997
Inventor Ritzdorf et al.
Assignee Semitool, Inc.
Group Art Unit Unknown
Examiner Unknown
Attorney's Docket No. SE10-0123
Title: Semiconductor Plating System Workpiece Support Having Workpiece-
Engaging Electrode With Pre-Conditioned Contact Face

ASSIGNMENT

PARTIES TO THE ASSIGNMENT:

INVENTORS:

Thomas L. Ritzdorf
P.O. Box 7010
Kalispell, MT 59904

Jeffrey I. Turner
P.O. Box 7010
Kalispell, MT 59904

ASSIGNEE:

Semitool, Inc.
Corporation of the State of Montana
P.O. Box 7010
Kalispell, MT 59904

BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed in a United States Patent Application Serial No. 08/940,686, filed September 30, 1997, and titled Semiconductor Plating System Workpiece Support Having Workpiece-Engaging Electrode With Pre-Conditioned Contact Face.

1 Semitool, Inc. desires to acquire the entire right, title and interest
2 in said inventions and with respect to any Letters Patent that may be
3 granted with respect to the inventions in both the United States and in
4 all foreign countries.

5 THE PARTIES AGREE AS FOLLOWS:

6 In consideration of good and valuable consideration, the receipt of
7 which is hereby acknowledged, INVENTORS have sold, assigned and
8 transferred to Semitool, Inc. the full and exclusive right to said
9 inventions in the United States and in all foreign countries.

10 INVENTORS do hereby sell, assign and transfer to Semitool, Inc.
11 the entire right, title and interest in the above-identified application and
12 to any reissues, divisions or continuations thereof, and hereby authorizes
13 the Commissioner of Patents and Trademarks to issue such Letters
14 Patent to Semitool, Inc. for the sole use of Semitool, Inc., its successors
15 or assigns.

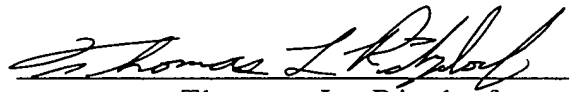
16 INVENTORS further agree to execute, at the request and expense
17 of Semitool, Inc. such other formal documents as may be required to
18 fully convey the interest transferred herein and will similarly execute any
19 applications papers required for the filing of any division, continuation
20 or reissue of the patent application or resulting Letters Patent; and will
21 generally do everything necessary or desirable to obtain and enforce
22 proper protection for the inventions assigned hereby.

23 INVENTORS further assign to Semitool, Inc. the whole right, title
24 and interest in the inventions disclosed in the application throughout all

1 countries foreign to the United States. Semitool, Inc. is hereby
2 authorized to apply for patents relating to the inventions in its own
3 name in countries where such procedure is proper; to claim the benefit
4 of the International Convention; to file and prosecute International
5 Applications relating to the inventions under the Patent Cooperation
6 Treaty; and to file and prosecute applications relating to the inventions
7 under the European Patent Convention. INVENTORS agree to execute
8 applications relating to the inventions in those countries and under those
9 conventions where it is necessary that the same be executed by the
10 inventor, and to execute assignments of such applications and the
11 resulting Letters Patent to Semitool, Inc. as well as all other necessary
12 papers in relation to such applications and Letters Patent.

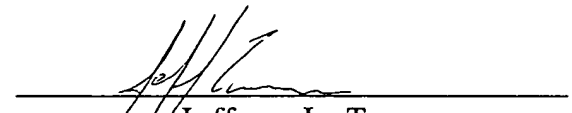
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14 Dated:

4/22/98


Thomas L. Ritzdorf

15
16 Dated:

4/21/98


Jeffrey I. Turner

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DECLARATION FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated
below next to my name.

I believe I am an original, first and joint inventor of the subject
matter which is claimed and for which a patent is sought on the
invention entitled Semiconductor Plating System Workpiece Support
Having Workpiece-Engaging Electrode With Pre-Conditioned Contact
Face, the specification of which was filed on September 30, 1997 as
United States Patent Application Serial Number 08/940,686.

I hereby state that I have reviewed and understand the contents
of the above-identified specification, including the claims, as amended by
any amendment referred to above.

I acknowledge the duty to disclose information which is material
to patentability as defined in 37 CFR §1.56.

I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d)
or §365(b) of any foreign application(s) for patent or inventor's
certificate, or §365(a) of any PCT International application which

1 designated at least one country other than the United States, listed
2 below and have also identified below, any foreign application for patent
3 or inventor's certificate, or PCT International application having a filing
4 date before that of the application on which priority is claimed:

5 Application Number: Not applicable.

6 Country: Not applicable.

7 Filing date: Not applicable.

8 I hereby declare that all statements made herein of my own
9 knowledge are true and that all statements made on information and
10 belief are believed to be true; and further that these statements were
11 made with the knowledge that willful false statements and the like so
12 made are punishable by fine or imprisonment, or both, under
13 Section 1001 of Title 18 of the United States Code and that such willful
14 false statements may jeopardize the validity of the application or any
15 patent issued thereon.

16 * * * * *

17 Full name of inventor: Thomas L. Ritzdorf

18 Inventor's Signature: 

19 Date: 4/22/98

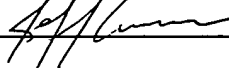
20 City of Residence: Kalispell, Montana

21 Citizenship: U.S.

22 Post Office Address: P.O. Box 7010, Kalispell, MT 59904
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* * * * *

Full name of inventor: Jeffrey I. Turner

Inventor's Signature: 

Date: 4/21/98

City of Residence: Kalispell, Montana

Citizenship: U.S.

Post Office Address: P.O. Box 7010, Kalispell, MT 59904

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